

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
VINOD JOSEPH MENEZES	12/19/2018
MANIKANDAN RR	12/19/2018
RAJAT CHAUHAN	12/19/2018
VIPUL KUMAR SINGHAL	12/19/2018
MAHESH MADHUKAR MEHENDEALE	12/19/2018
KAICHIEEN TSAI	12/18/2018
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Street Address:	12500 TI BOULEVARD
Internal Address:	M/S 3999
City:	DALLAS
State/Country:	TEXAS
Postal Code:	75243
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16227314
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	TI-78882
NAME OF SUBMITTER:	DAVID M. WILSON
SIGNATURE:	/David M. Wilson/
DATE SIGNED:	12/20/2018

Total Attachments: 4

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ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made.

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 12500 TI Boulevard, M/S 3999, Dallas, Texas 75243, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon, as well as to U.S. Provisional Application No(s). _____ filed _____.

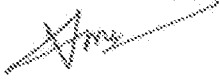
NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign unto the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in and to the said application(s) and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof, and I hereby authorize and request the Patent and Trademark Office to issue all patents for said invention, or patents resulting therefrom, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my corresponding rights to the invention disclosed in said application in all other countries of the world, including the right to claim priority, file applications and obtain patents under the terms of the Paris Convention for the Protection of Industrial Property, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

I authorize the later insertion of the nonprovisional application number and filing date herein below.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year,

TITLE	LOAD CURRENT MEASUREMENT		
NONPROVISIONAL APPLICATION NO.	16/227,314	FILING DATE	December 20, 2018
SIGNATURE OF INVENTOR			
PRINTED NAME OF INVENTOR	Vinod Joseph MENEZES		
DATE	19th Dec, 2018		
RESIDENCE (CITY AND STATE)	Bengaluru, India		

SIGNATURE OF INVENTOR	<i>R. R. Manikandan</i>
PRINTED NAME OF INVENTOR	Manikandan RR
DATE	19 th December, 2018
RESIDENCE (CITY AND STATE)	Bengaluru, India

SIGNATURE OF INVENTOR	<i>Rajat Chauhan</i>
PRINTED NAME OF INVENTOR	Rajat CHAUHAN
DATE	19 th Dec 2018
RESIDENCE (CITY AND STATE)	Bengaluru, India

SIGNATURE OF INVENTOR	<i>Vipul K Singhal</i>
PRINTED NAME OF INVENTOR	Vipul Kumar SINGHAL
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PRINTED NAME OF INVENTOR	Mahesh Madhukar MEHENDALE
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SIGNATURE OF INVENTOR	
PRINTED NAME OF INVENTOR	Kaichien TSAI
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RESIDENCE (CITY AND STATE)	Allen, Texas

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